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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Mona M. Eissa

Docket No: TI-28394.1

Serial No: 10/621,879

Conf. No: 3091

Examiner: Kin Chan Chen

Art Unit: 1765

Filed: 07/17/2003

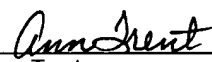
For: EFFECTIVE SOLUTION AND PROCESS TO WET-ETCH METAL-ALLOY FILMS IN SEMICONDUCTOR PROCESSING

REVISED AMENDMENT UNDER 37 C.F.R. § 1.111
IN RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 7-27-05.


Ann Trent

Dear Sir:

Responsive to the Notice of Non-Compliant Amendment mailed July 18, 2005, in connection with the above identified application, Applicant respectfully submits the following amendments and remarks.